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MOSFET – Single N-Channel, SUPERFET® III, FRFET®

650 V, 30 A, 110 mΩ

NVH4L110N65S3F

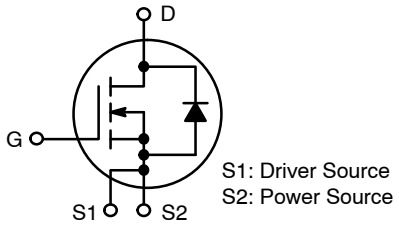
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Features

- Ultra Low Gate Charge & Low Effective Output Capacitance
- Lower FOM ($R_{DS(on)\ max.}$ x $Q_{g\ typ.}$ & $R_{DS(on)\ max.}$ x E_{OSS})
- AEC−Q101 Qualified and PPAP Capable
- These Devices are Pb−Free and are RoHS Compliant

V_{DSS}	$R_{DS(ON)}$ MAX	I_D MAX
650 V	110 mΩ @ 10 V	30 A



POWER MOSFET

MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain−to−Source Voltage	V_{DSS}	650	V
Gate−to−Source Voltage − DC	V_{GSS}	±30	V
Gate−to−Source Voltage − AC (f > 1 Hz)	V_{GSS}	±30	V
Drain Current − Continuous (T_C = 25°C)	I_D	30	A
Drain Current − Continuous (T_C = 100°C)	I_D	19.5	A
Drain Current − Pulsed (Note 3)	I_{DM}	69	A
Power Dissipation (T_C = 25°C)	P_D	240	W
Power Dissipation − Derate Above 25°C	P_D	1.92	W/°C
Operating Junction and Storage Temperature Range	T_J, T_{STG}	−55 to +150	°C
Single Pulsed Avalanche Energy (Note 4)	E_{AS}	380	mJ
Repetitive Avalanche Energy (Note 3)	E_{AR}	2.4	mJ
MOSFET dv/dt	dv/dt	100	V/ns
Peak Diode Recovery dv/dt (Note 5)	dv/dt	50	V/ns
Max. Lead Temperature for Soldering Purposes (1/8″ from case for 5 s)	T_L	300	°C

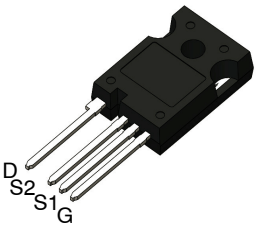
THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction−to−Case, Max. (Notes 1, 2)	$R_{\theta JC}$	0.52	°C/W
Thermal Resistance, Junction−to−Ambient, Max. (Notes 1, 2)	$R_{\theta JA}$	40	

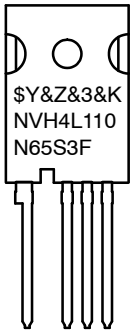
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The entire application environment impacts the thermal resistance values shown. They are not constants and are only valid for the particular conditions noted.
2. Assembled to an infinite heatsink with perfect heat transfer from the case (assumes 0 K/W thermal interface).
3. Repetitive rating: pulse−width limited by maximum junction temperature.
4. I_{AS} = 3.5 A, R_G = 25 Ω, starting T_J = 25°C.
5. I_{SD} ≤ 15 A, di/dt ≤ 200 A/μs, V_{DD} ≤ 400 V, starting T_J = 25°C.

MARKING DIAGRAM



TO−247−4LD
CASE 340CJ



$Y	= ON Semiconductor Logo
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&3	= Data Code (Year & Week)
&K	= Lot
NVH4L110N65S3F	= Specific Device Code

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Device	Package	Shipping
NVH4L110N65S3F	TO−247−4LD (Pb−Free)	30 Units / Tube

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ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain−to−Source Breakdown Voltage	BV_{DSS}	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	650			V
Drain−to−Source Breakdown Voltage	BV_{DSS}	V_{GS} = 0 V, I_D = 10 mA, T_J = 150°C	700			V
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	I_D = 20 mA, Referenced to 25°C		610		mV/°C
Zero Gate Voltage Drain Current	I_{DSS}	V_{GS} = 0 V, V_{DS} = 650 V			10	μA
		V_{DS} = 520 V, T_C = 125°C		44		
Gate−to−Body Leakage Current	I_{GSS}	V_{GS} = ±30 V, V_{DS} = 0 V			±100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(th)}$	V_{GS} = V_{DS}, I_D = 0.74 mA	3.0		5.0	V
Threshold Temperature Coefficient	$\Delta V_{GS(th)}/\Delta T_J$	V_{GS} = V_{DS}, I_D = 0.74 mA		−9.2		mV/°C
Static Drain−to−Source On Resistance	$R_{DS(on)}$	V_{GS} = 10 V, I_D = 15 A		93	110	mΩ
Forward Transconductance	g_{FS}	V_{DS} = 20 V, I_D = 15 A		17		S
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{iss}	V_{GS} = 0 V, V_{DS} = 400 V, f = 1 MHz		2530		pF
Output Capacitance	C_{oss}			55.4		
Reverse Transfer Capacitance	C_{rss}			7.5		
Effective Output Capacitance	$C_{oss(eff.)}$	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		512		pF
Energy Related Output Capacitance	$C_{oss(er.)}$	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		96		pF
Total Gate Charge at 10 V	$Q_{G(TOT)}$	V_{GS} = 10 V, V_{DS} = 400 V, I_D = 15 A (Note 6)		59		nC
Threshold Gate Charge	$Q_{G(TH)}$			11		
Gate−to−Source Gate Charge	Q_{GS}			18		
Gate−to−Drain “Miller” Charge	Q_{GD}			24		
Equivalent Series Resistance	ESR	f = 1 MHz		1.6		Ω
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	$t_{d(on)}$	V_{GS} = 10 V, V_{DD} = 400 V, I_D = 15 A, R_g = 4.7 Ω (Note 6)		24.6		ns
Turn-On Rise Time	t_r			16.4		ns
Turn-Off Delay Time	$t_{d(off)}$			59.5		ns
Turn-Off Fall Time	t_f			6.4		ns
SOURCE−DRAIN DIODE CHARACTERISTICS						
Maximum Continuous Source−to−Drain Diode Forward Current	I_S	V_{GS} = 0 V			30	A
Maximum Pulsed Source−to−Drain Diode Forward Current	I_{SM}	V_{GS} = 0 V			69	A
Source−to−Drain Diode Forward Voltage	V_{SD}	V_{GS} = 0 V, I_{SD} = 15 A			1.3	V
Reverse Recovery Time	t_{rr}	V_{GS} = 0 V, dI_F/dt = 100 A/μs, I_{SD} = 15 A		89.2		ns
Charge Time	t_a			78.2		
Discharge Time	t_b			11.5		
Reverse Recovery Charge	Q_{rr}			312		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

6. Essentially independent of operating temperature typical characteristics.

TYPICAL CHARACTERISTICS

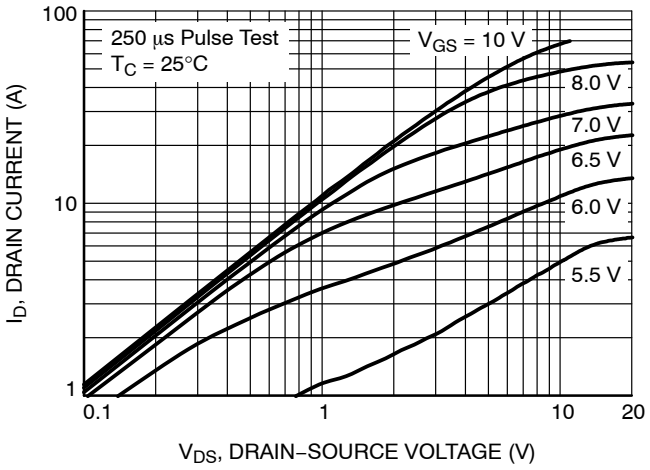


Figure 1. On−Region Characteristics 25°C

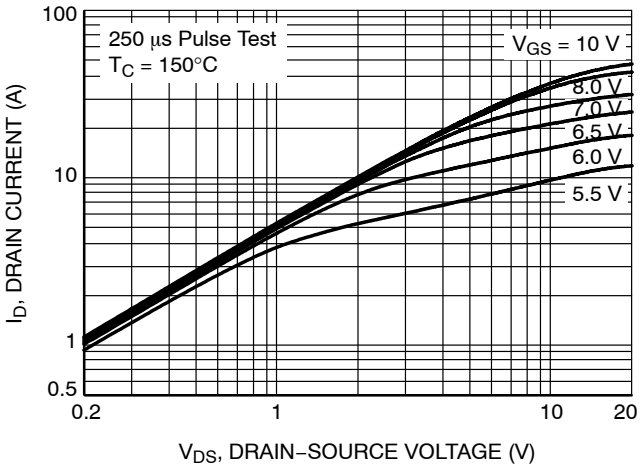


Figure 2. On−Region Characteristics 150°C

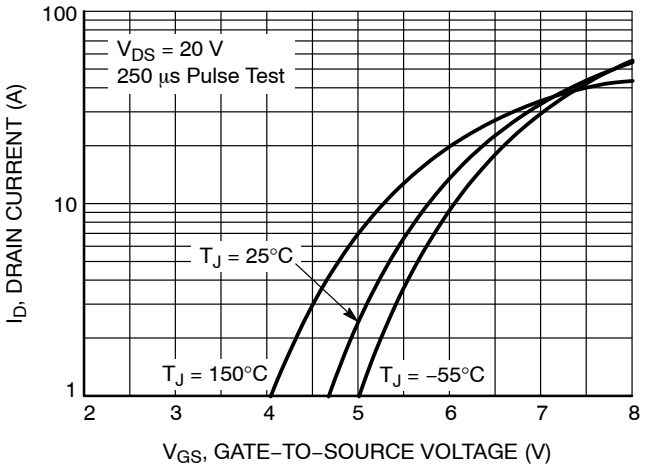


Figure 3. Transfer Characteristics

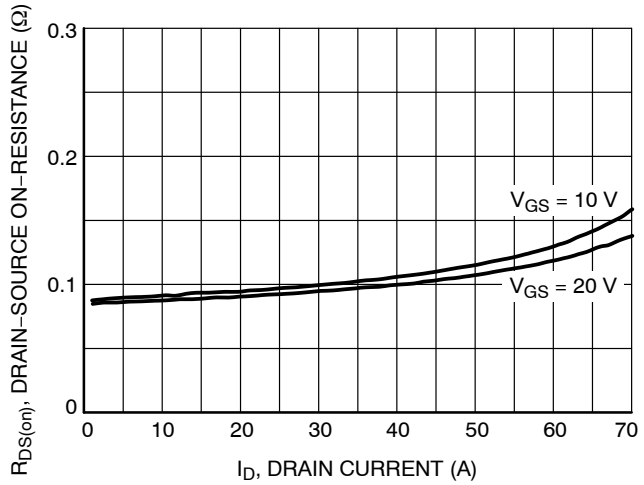


Figure 4. On−Resistance Variation vs. Drain Current and Gate Voltage

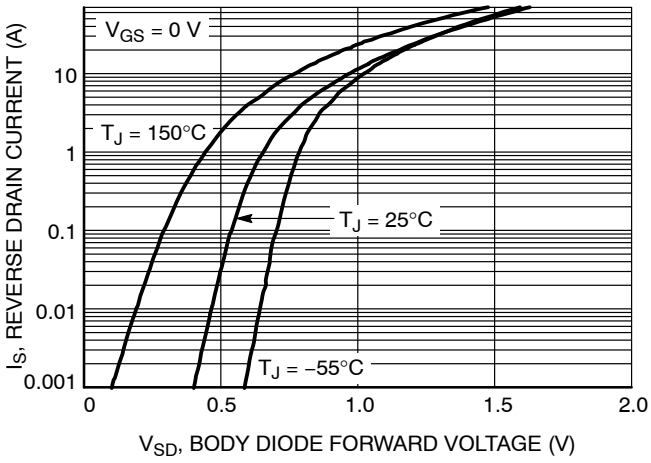


Figure 5. Body Diode Forward Voltage Variation vs. Source Current and Temperature

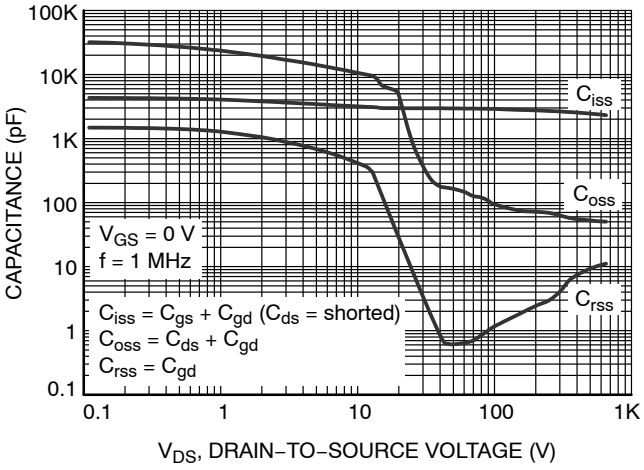


Figure 6. Capacitance Characteristics

TYPICAL CHARACTERISTICS

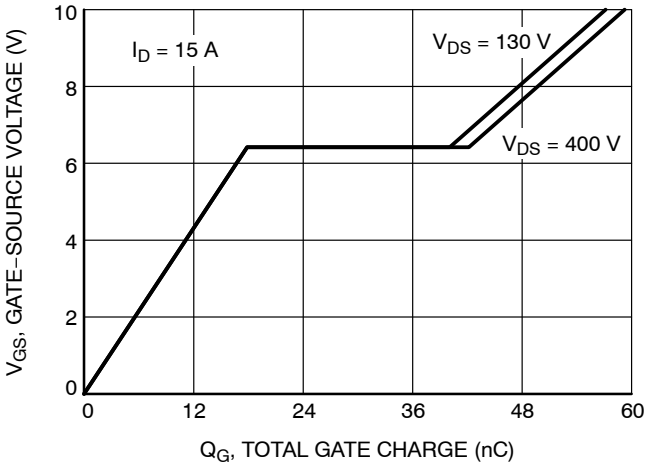


Figure 7. Gate Charge Characteristics

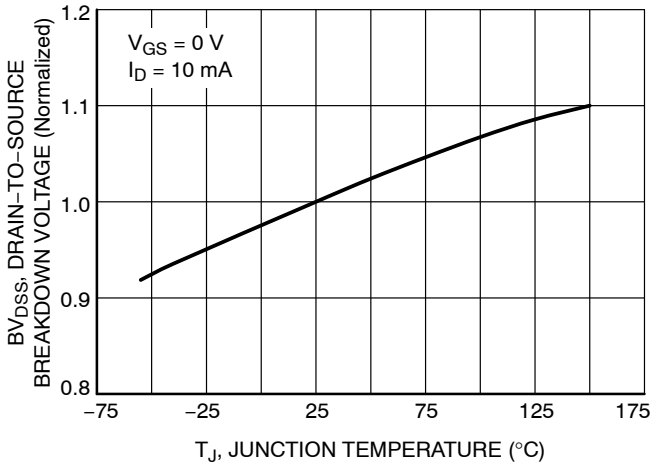


Figure 8. Breakdown Voltage Variation vs. Temperature

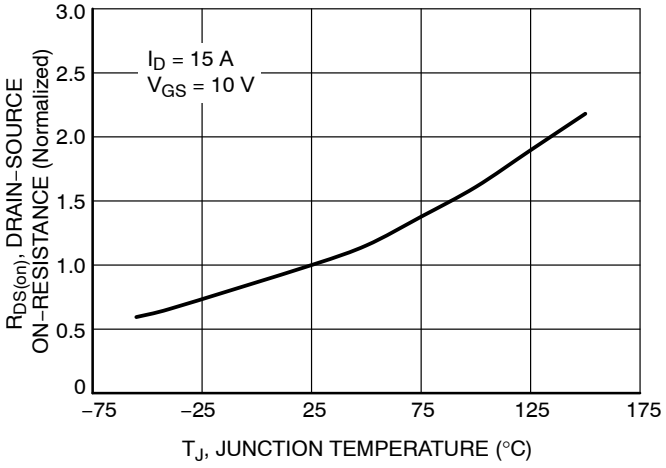


Figure 9. On−Resistance Variation vs. Temperature

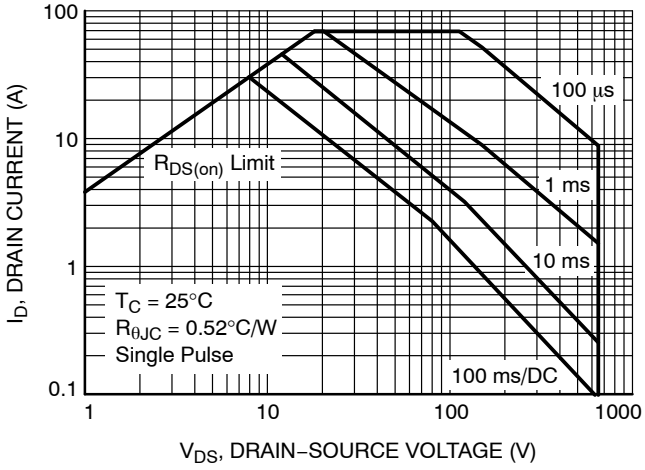


Figure 10. Maximum Safe Operating Area

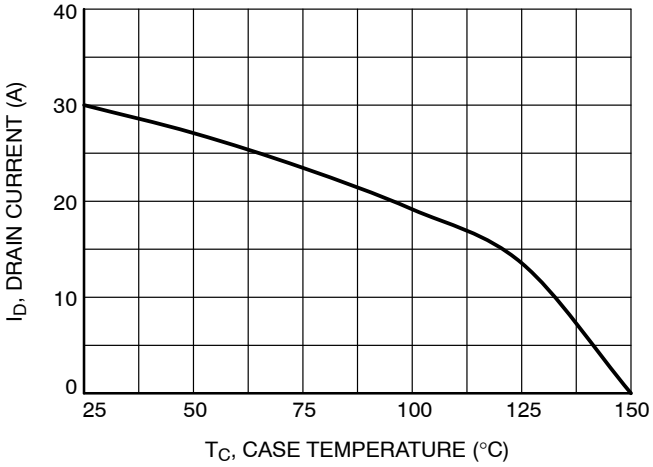


Figure 11. Maximum Drain Current vs. Case Temperature

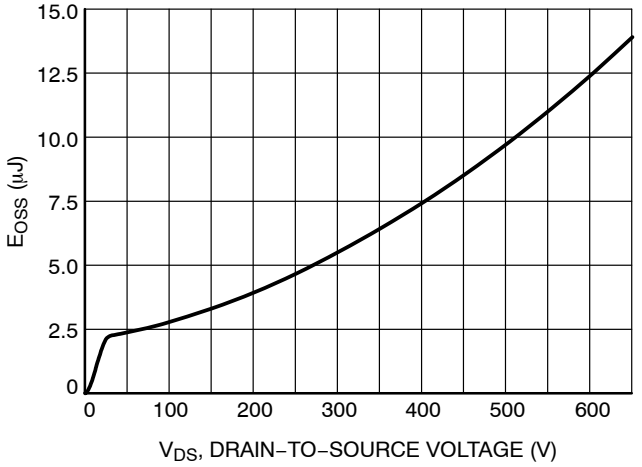


Figure 12. E_{OSS} vs. Drain−to−Source Voltage

TYPICAL CHARACTERISTICS

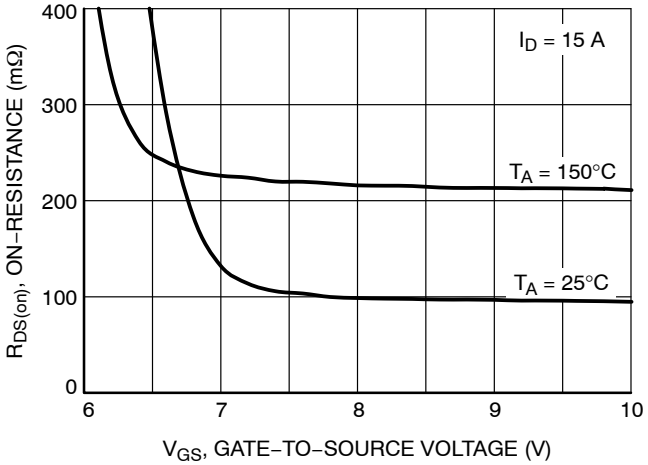


Figure 13. $R_{DS(on)}$ vs. Gate Voltage

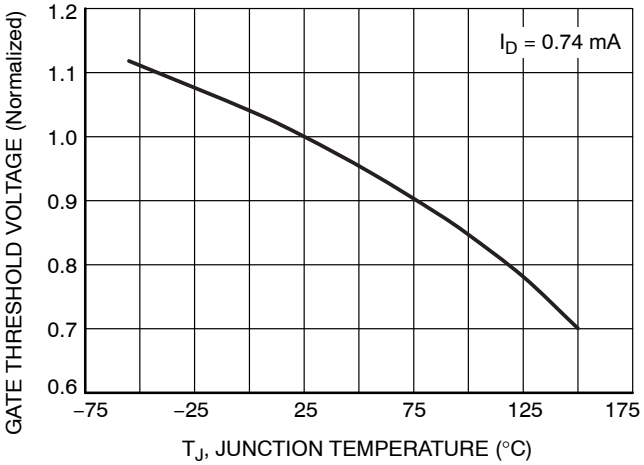
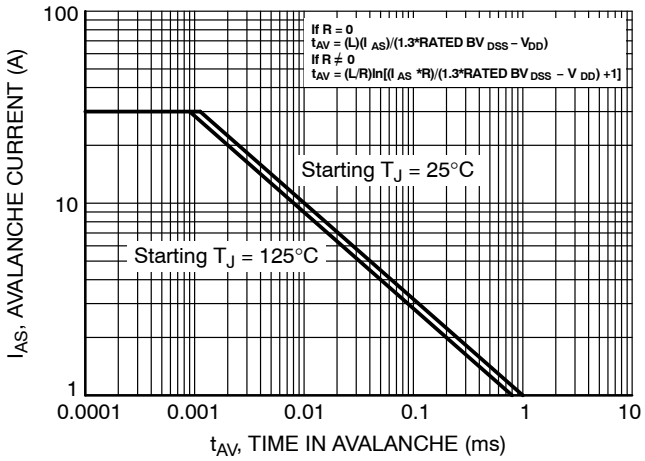


Figure 14. Normalized Gate Threshold Voltage vs. Temperature



NOTE: Refer to Application Notes AN7514 and AN7515

Figure 15. Unclamped Inductive Switching Capability

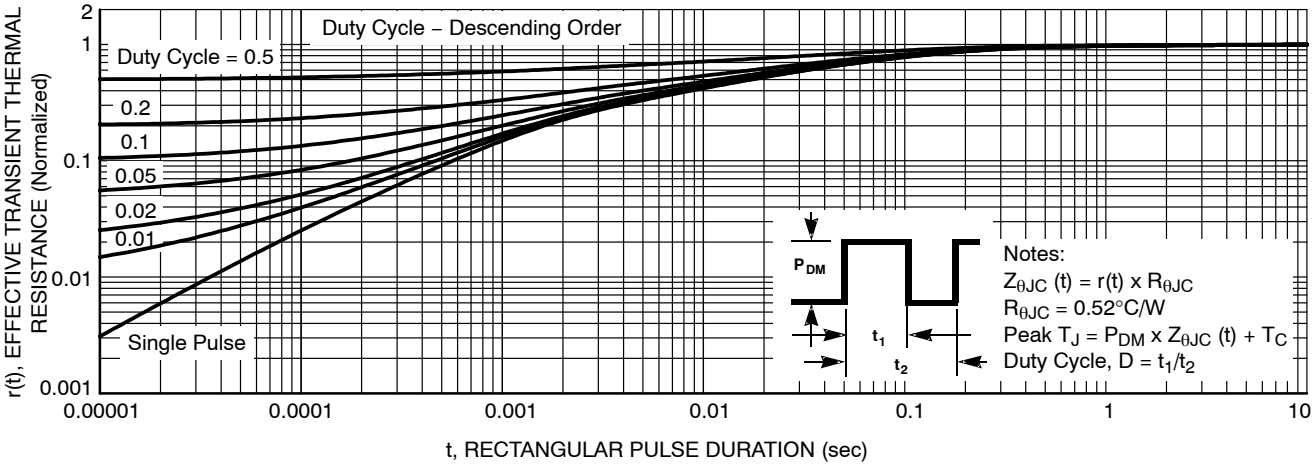


Figure 16. Transient Thermal Response

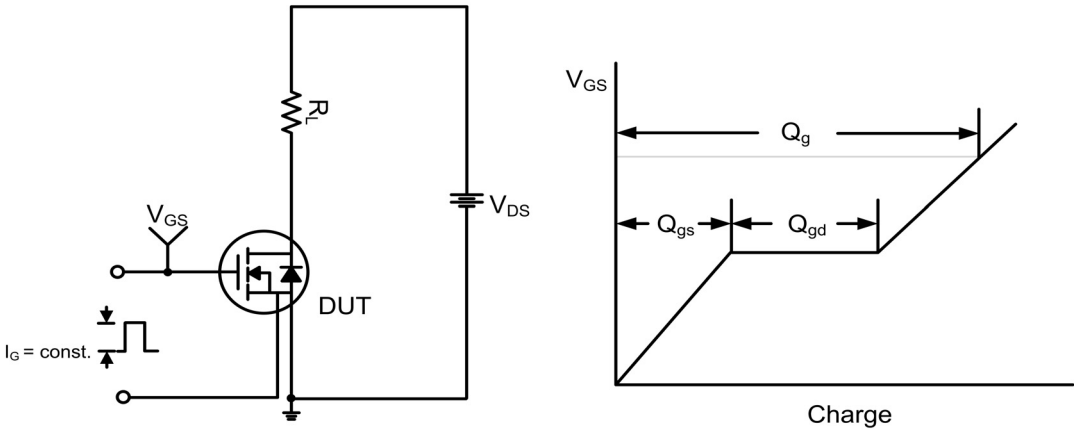


Figure 17. Gate Charge Test Circuit & Waveform

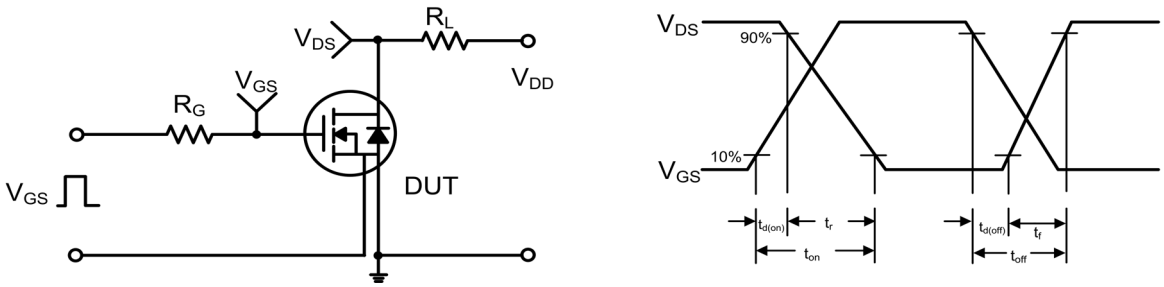


Figure 18. Resistive Switching Test Circuit & Waveforms

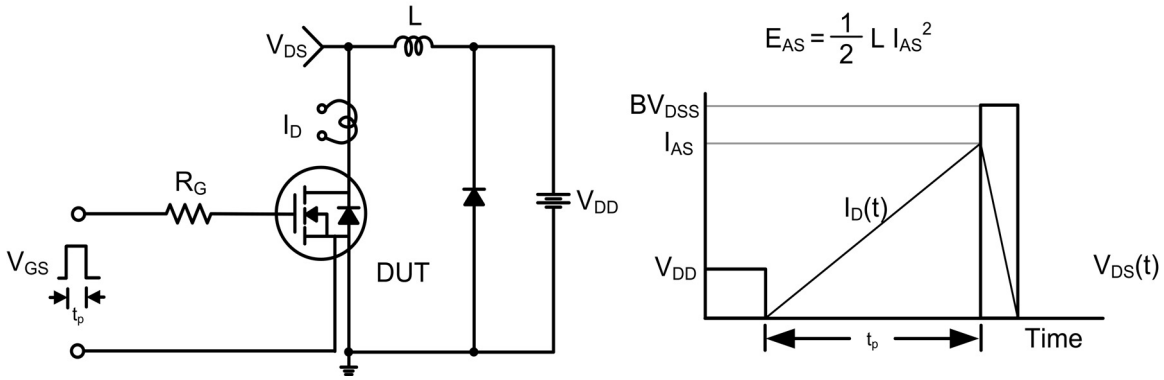


Figure 19. Unclamped Inductive Switching Test Circuit & Waveforms

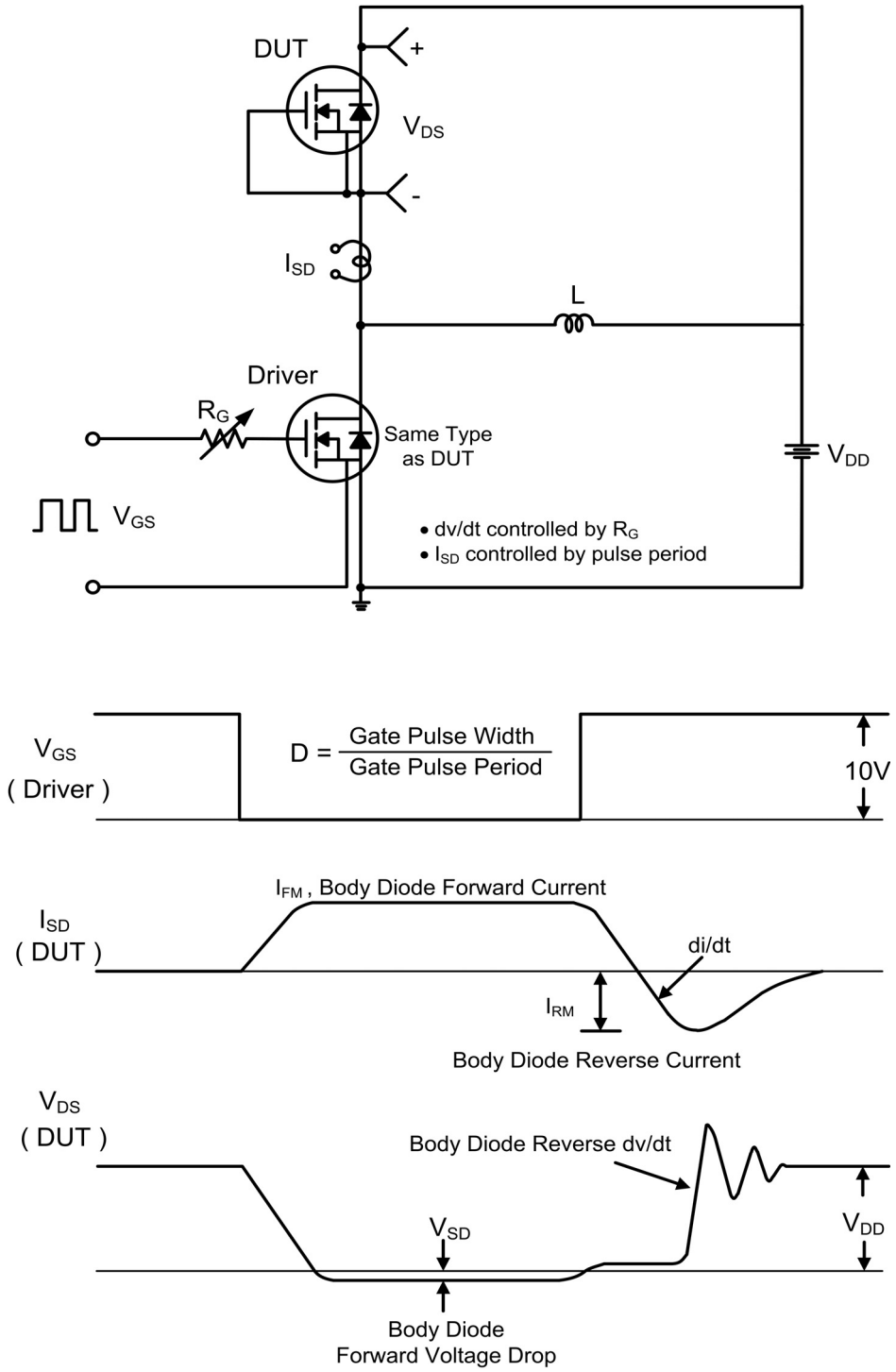
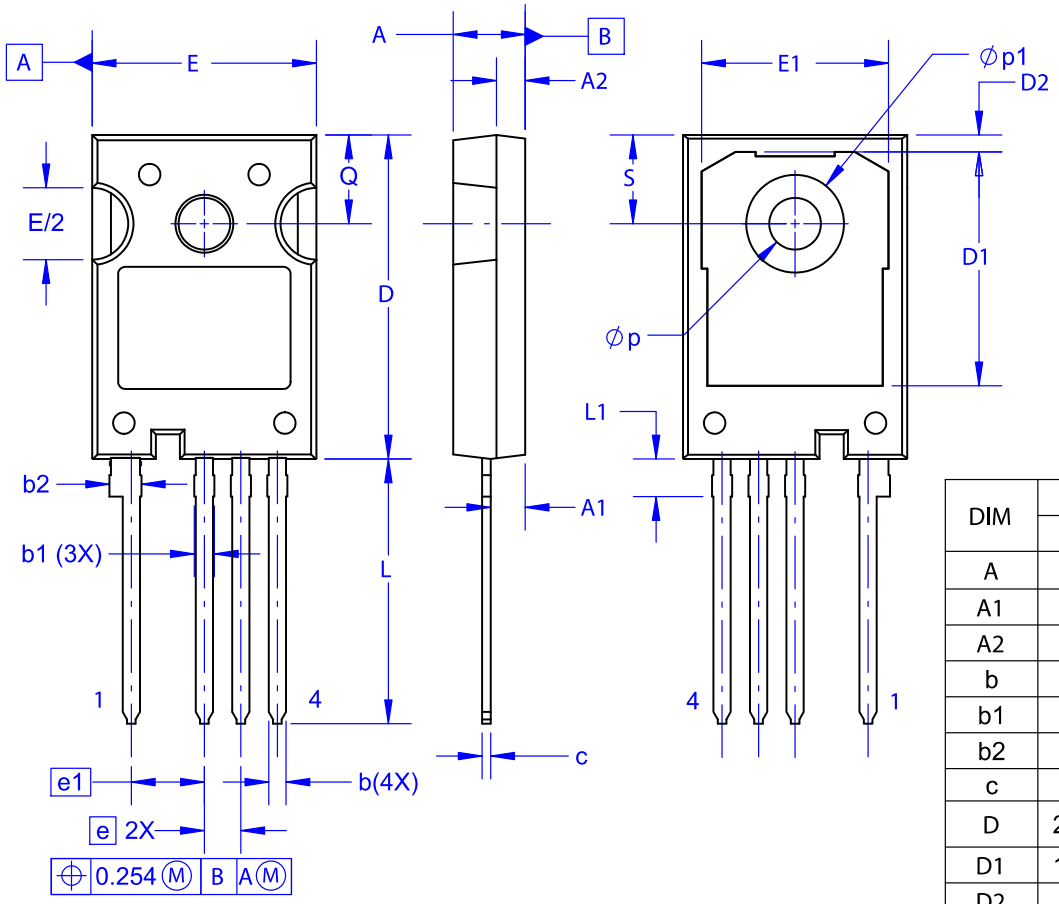


Figure 20. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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TO−247−4LD
CASE 340CJ
ISSUE A



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	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.10	2.40	2.70
A2	1.80	2.00	2.20
b	1.07	1.20	1.33
b1	1.20	1.40	1.60
b2	2.02	2.22	2.42
c	0.50	0.60	0.70
D	22.34	22.54	22.74
D1	16.00	16.25	16.50
D2	0.97	1.17	1.37
e	2.54 BSC		
e1	5.08 BSC		
E	15.40	15.60	15.80
E1	12.80	13.00	13.20
E/2	4.80	5.00	5.20
L	18.22	18.42	18.62
L1	2.42	2.62	2.82
p	3.40	3.60	3.80
p1	6.60	6.80	7.00
Q	5.97	6.17	6.37
S	5.97	6.17	6.37

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